**TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC** 

# TLP3061(S),TLP3062(S),TLP3063(S)

**OFFICE MACHINE** HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3061 (S), TLP3062 (S), TLP3063 (S) consist of a zero voltage crossing turn-on photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

•	Peak Off-State Voltage	: 600 V (min)

- Trigger LED Current
- **On-State** Current
  - **Isolation Voltage** : 5000 Vrms (min)
- UL Recognized
- BSI Approved

- : 15 mA (max) (TLP3061(S))
  - 10 mA (max) (TLP3062(S)) 5 mA (max) (TLP3063(S))
- : 100 mA (max)
- : UL1577, File No. E67349 SEMKO Approved : SS EN60065
  - SS EN60950, File No.9841113 : BS EN60065, File No.8385
    - BS EN60950, File No.8386
- Option (D4) type

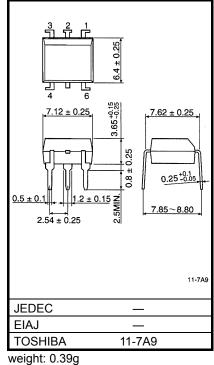
VDE approved: DIN EN60747-5-2 Approved No. 40009302

Maximum operating insulation voltage: 890VPK Highest permissible over voltage: 8000VPK

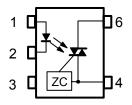
#### (Note): When a EN60747-5-2 approved type is needed, please designate the "Option (D4)"

Construction mechanical rating

	7.62 mm pich Standard Type	10.16 mm pich TLPxxxxF type		
Creepage Distance	7.0 mm (Min)	8.0 mm (Min)		
Clearance	7.0 mm (Min)	8.0 mm (Min)		
Insulation Thickness	0.5 mm (Min)	0.5 mm (Min)		



#### **Pin Configuration** (top view)



1: Anode 2: Cathode 3: N.C. 4:Terminal 1 6:Terminal 2

ZC:Zero-cross Circuit

Unit: mm

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current		IF	50	mA
	Forward current derating (Ta ≥ 53°	ΔI <sub>F</sub> / °C	-0.7	mA / °C	
0	Peak forward current (100 µs pulse, 100 pps)	I <sub>FP</sub>	1	А	
LED	Power dissipation	PD	100	mW	
	Power dissipation derating (Ta ≥ 2	ΔP <sub>D</sub> / °C	-1.0	mW / °C	
	Reverse voltage	everse voltage			V
	Junction temperature	Тj	125	°C	
	Off-state output terminal voltage	V <sub>DRM</sub>	600	V	
		Ta = 25°C	-	100	
	On-state RMS current	Ta = 70°C	IT(RMS)	50	mA
	On-state current derating (Ta ≥ 25	ΔI <sub>T</sub> / °C	-1.1	mA / °C	
Detector	Peak on-state current (100µs pulse, 120 pps)		I <sub>TP</sub>	2	А
Ğ	Peak nonrepetitive surge current (P <sub>w</sub> = 10 ms, DC = 10%)	I <sub>TSM</sub>	1.2	А	
	Power dissipation	PD	300	mW	
	Power dissipation derating (Ta ≥ 2	ΔP <sub>D</sub> / °C	-4.0	mW / °C	
	Junction temperature	Тj	115	°C	
Storag	e temperature range		T <sub>stg</sub>	-55~150	°C
Operat	ting temperature range	T <sub>opr</sub>	-40~100	°C	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C
Total package power dissipation			PT	330	mW
Total package power dissipation derating $(Ta \ge 25^{\circ}C)$		ΔP <sub>T</sub> /°C	-4.4	mW / °C	
	Isolation voltage (AC, 1 min., R.H.≤ 60%) (Note 1)			5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

## **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>AC</sub>	—	—	240	Vac
Forward current	IF*	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	_	_	1	А
Operating temperature	T <sub>opr</sub>	-25		85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

※ In the case of TLP3062

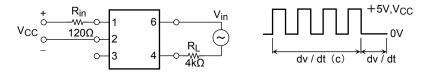
# Individual Electrical Characteristics (Ta = 25°C)

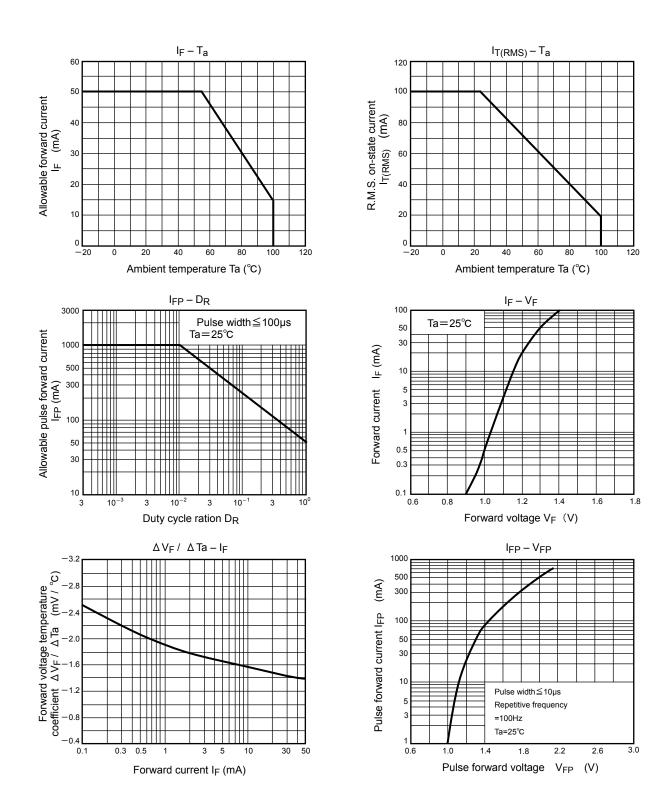
	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	—	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	10	_	pF
Detector	Peak off-state current	IDRM	V <sub>DRM</sub> = 600 V	_	10	1000	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA	_	1.7	3.0	V
	Holding current	Iн	—	_	0.6	—	mA
	Critical rate of rise of off-state voltage	dv / dt	V <sub>in</sub> = 240 Vrms, Ta = 85°C (Fig.1)	200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt (c)	V <sub>in</sub> = 60 Vrms, I <sub>T</sub> = 15mA (Fig.1)	_	0.2	_	V / µs

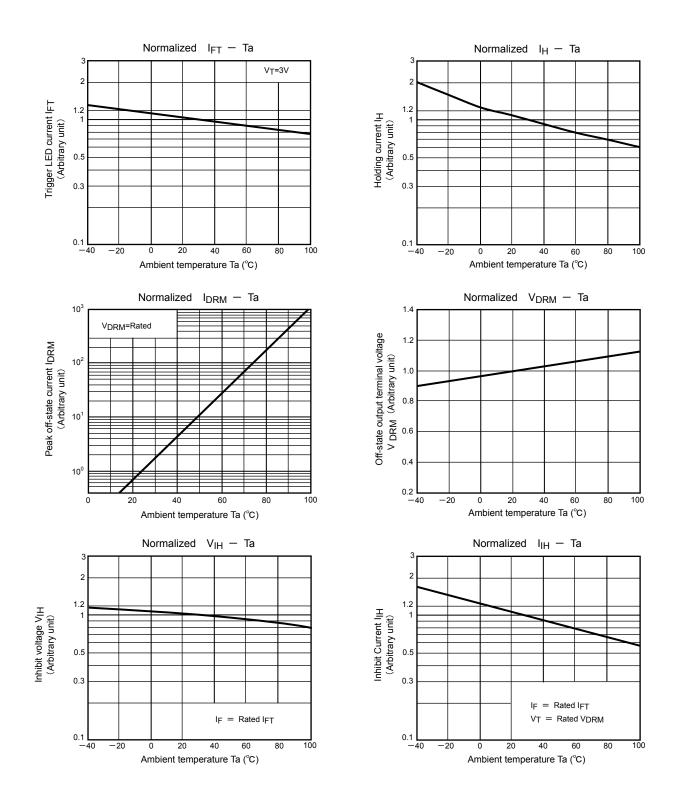
## **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
	TLP3061(S)	I <sub>FT</sub> V <sub>T</sub> = 6 V	V <sub>T</sub> = 6 V	_	_	15	mA
Trigger LED current	TLP3062(S)			_	5	10	
	TLP3063(S)			_	_	5	
Inhibit voltage		VIH	I <sub>F</sub> = rated I <sub>FT</sub>	_	_	50	V
Leakage in inhibited state		liH	I <sub>F</sub> = rated I <sub>FT</sub> V <sub>T</sub> = rated V <sub>DRM</sub>	_	100	300	μA
Capacitance input to output		CS	V <sub>S</sub> = 0, f = 1 MHz	_	0.8		pF
Isolation resistance		R <sub>S</sub>	V <sub>S</sub> = 500 V (R.H.≤ 60%)	5×10 <sup>10</sup>	10 <sup>14</sup>		Ω
Isolation voltage		BVS	AC, 1 minute	5000	_		
			AC, 1 second, in oil	_	10000	_	Vrms
			DC, 1 minute, in oil	_	10000		V <sub>dc</sub>

Fig. 1 dv / dt test circuit







## **RESTRICTIONS ON PRODUCT USE**

20070701-EN

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